

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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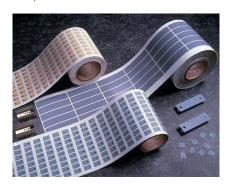




#### The Original Polyimide-Based Insulator

#### **Features and Benefits**

- Thermal impedance: 0.48°C-in²/W (@50 psi)
- Withstands high voltages
- · High dielectric strength
- Very durable



Sil-Pad K-4 uses a specially developed film which has high thermal conductivity, high dielectric strength and is very durable. Sil-Pad K-4 combines the thermal transfer properties of well-known Sil-Pad rubber with the physical properties of a film.

Sil-Pad K-4 is a durable insulator that withstands high voltages and requires no thermal grease to transfer heat. Sil-Pad K-4 is available in customized shapes and sizes.

TYPICAL PROPERTIES OF SIL-PAD K-4					
IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Gray		Gray		Visual	
Polyimide		Polyimide		_	
0.006		0.152		ASTM D374	
90		90		ASTM D2240	
30		5		ASTM D1458	
40		40		ASTM D412	
5000		34		ASTM D412	
-76 to 356		-60 to 180		_	
6000		6000		ASTM D149	
5.0		5.0		ASTM D150	
1012		1012		ASTM D257	
VTM-O		VTM-O		U.L.94	
0.9		0.9		ASTM D5470	
THERMAL PERFORMANCE vs PRESSURE					
sure (psi)	10	25	50	100	200
TO-220 Thermal Performance (°C/W)		3.43	3.13	2.74	2.42
Thermal Impedance (°C-in²/W) (1)		0.68	0.48	0.42	0.38
	MPERIA   Gr	MPERIAL VALUE	MPERIAL VALUE   METRIC     Gray   Gray   Gray     Polyimide   Poly     0.006   0.     90   5     30   40   6     5000   -76 to 356   -60 to 10     6000   60     5.0   5     1012   1     VTM-O   VT     0.9   GURE     sure (psi)   10   25     e (°C/W)   3.66   3.43	IMPERIAL VALUE         METRIC VALUE           Gray         Gray           Polyimide         Polyimide           0.006         0.152           90         90           30         5           40         40           5000         34           -76 to 356         -60 to 180           6000         6000           5.0         5.0           1012         1012           VTM-O         VTM-O           SURE         sure (psi)         10         25         50           e (°C/W)         3.66         3.43         3.13	IMPERIAL VALUE         METRIC VALUE         TEST M           Gray         Gray         Vis           Polyimide         Polyimide         -           0.006         0.152         ASTM           90         90         ASTM           30         5         ASTM           40         40         ASTM           5000         34         ASTM           -76 to 356         -60 to 180         -           6000         6000         ASTM           5.0         5.0         ASTM           VTM-O         VTM-O         U.L           0.9         0.9         ASTM           GURE         SURE         SURE           sure (psi)         10         25         50         100           e (°C/W)         3.66         3.43         3.13         2.74

1) The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

### **Typical Applications Include:**

• Power supplies

Motor controls

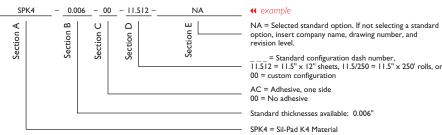
Power semiconductors

## **Configurations Available:**

- Sheet form, die-cut parts and roll form
- With or without pressure sensitive adhesive

### **Building a Part Number**

# **Standard Options**



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad®: U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others.